



Product Change Notification

Change Notification #: 116144 - 00
Change Title: Intel® SSD 760p Series and Intel® SSD Pro 7600p Series Products, PCN 116144-00, Documentation, Booklet change
Date of Publication: March 08, 2018

Key Characteristics of the Change:

Documentation



Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	March 26, 2018
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Description of Change to the Customer:

The Intel® SSD 760p Series and Intel® SSD Pro 7600p Series Product SKUs listed in the Products Affected Table below will have the following changes to the warranty booklet:

1. Adding the Ukraine logo (page 2)

Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA	EU Single Point of Contact: Intel Corporation (UK) Ltd. Attn: Corp. Quality Pipers Way, Swindon, Wiltshire SN3 1RJ UK
	
	In the EU, this symbol means that this product must not be disposed of with household waste. It is your responsibility to bring it to a designated collection point for the recycling of waste electrical and electronic equipment. For more information, please contact your local waste collection center or your point of purchase.
	Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709A requirements, and the PCB/Substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.
	Intel and the Intel logo are trademarks of Intel Corporation in the U.S. and/or other countries.
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2. Addition of Taiwan RoHS table (-002 booklet page)

限用物質含有情況標示聲明書
Declaration of the Presence Condition of the Restricted Substances Marking

設備名稱：固態硬碟，型號(型式)：SSDXXXXXX(系列型號參見次頁)						
Equipment name: Type designation (Type)						
單元 Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁶⁺)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚Polybrominated diphenyl ethers (PBDE)
外殼	○	○	○	○	○	○
電路板組件	○	○	○	○	○	○
電線/連接器	○	○	○	○	○	○
配件	○	○	○	○	○	○
<p>備考1. “超出0.1 wt %”及“超出0.01 wt %”係指限用物質之百分比含量超出百分比含量基準值。 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.</p> <p>備考2. “○”係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2: “o” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.</p> <p>備考3. “-”係指該項限用物質為排除項目。 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.</p>						

茲切結保證所提供之商品限用物質含有情況標示內容係經執行測試作業或採適當之品質管理措施，並備置前述相關文件，確認正確無誤後提供貴局。並同意配合貴局執行後市場管理作業所需，依商品檢驗法第49條之規定，於限期28個工作天內提供相關證明文件以供審查。
I hereby ensure that “the presence conditions of the restricted substance” provided above have been proved by testing or appropriate quality control measures, and make sure the relevant documents provided are correct and ready. Also, I agree to cooperate with BSMI, as the Article 49 of the Commodity Inspection Act stipulates, to provide the relevant documents, if needed, for verification within 28 working days when BSMI carries out the market surveillance activities.

3. New ICS contact (page 49)

Intel® Customer Support Links

<p>Memory and Storage Warranty</p> <p>www.intel.com/ssdmoduleWarranty</p> 	<p>Memory and Storage Contact Phone Numbers</p> <p>www.intel.com/ssdmoduleContact</p> 
<p>Memory and Storage Contact Support Options Page</p> <p>www.intel.com/ssdmoduleSupport</p> 	<p>Memory and Storage Web Self-Help Support home page</p> <p>www.intel.com/ssdmoduleInfo</p> 

Customer Impact of Change and Recommended Action:

There is no change to the form, fit, function, quality or reliability of the product. This change affects the warranty booklet inside the packaging.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD 760p Series (1.024TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKW010T8X1	962568
Intel® SSD 760p Series (2.048TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKW020T8X1	962569
Intel® SSD 760p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box 10 Pack	SSDPEKKW128G8XT	963289
Intel® SSD 760p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box 10 Pack	SSDPEKKW256G8XT	963290
Intel® SSD 760p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box 10 Pack	SSDPEKKW512G8XT	963291
Intel® SSD Pro 7600p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF128G8X1	963303
Intel® SSD Pro 7600p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF256G8X1	963304
Intel® SSD Pro 7600p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF512G8X1	963305
Intel® SSD Pro 7600p Series (1.024TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF010T8X1	963306
Intel® SSD Pro 7600p Series (2.048TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Retail Box Single Pack	SSDPEKKF020T8X1	963307

PCN Revision History:

Date of Revision:

March 8, 2018

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Europe Email: eccb@intel.com

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